

## Maximum Ratings (Per Leg) (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	150	V
Average Rectified Output Current (F	Per Leg) (Total)	lo	5 10	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		IFSM	100	А
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10000	V/µs

# **Thermal Characteristics (Per Leg)**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{ hetaJC}$	5	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	20	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

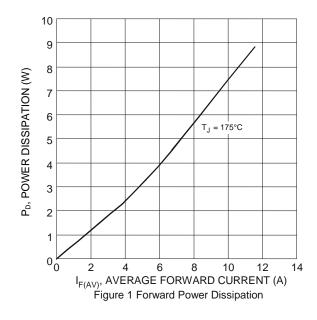
## Electrical Characteristics (Per Leg) (@TA = +25°C, unless otherwise specified.)

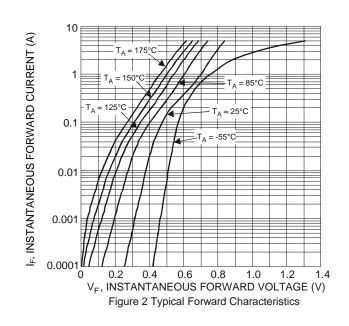
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Compared Voltage Drop	V <sub>F</sub>		0.83	0.89	· · · · · · · · · · · · · · · · · · ·	$I_F = 5A, T_J = +25^{\circ}C$
Forward Voltage Drop		_	_	0.81		$I_F = 5A$ , $T_J = +125$ °C
Lockago Current (Note C)	I <sub>R</sub>	_	_	0.05	A	$V_R = 150V, T_J = +25^{\circ}C$
Leakage Current (Note 6)		_	_	10	mA	V <sub>R</sub> = 150V, T <sub>J</sub> = +125°C

Notes: 5. Test

5. Test with 2 inch Al board.

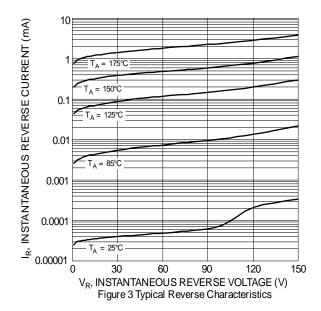
6. Short duration pulse test used to minimize self-heating effect.

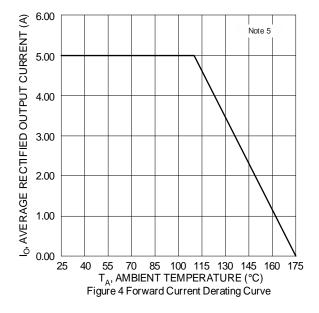










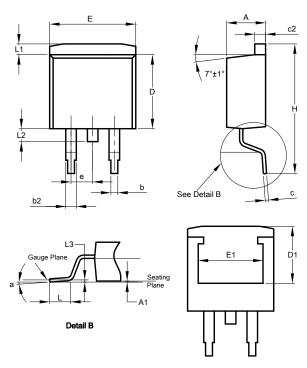




## **Package Outline Dimensions**

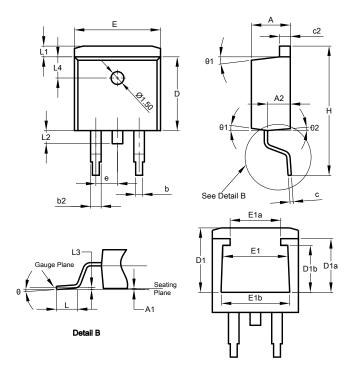
Please see http://www.diodes.com/package-outlines.html for the latest version.

### (1) Package Type: TO263AB (D2PAK)



TO263AB (D2PAK)			
Dim	Min	Max	Тур
Α	4.07	4.82	-
A1	0.00	0.25	-
b	0.51	0.99	-
b2	1.15	1.77	-
С	0.356	0.73	-
c2	1.143	1.65	-
D	8.39	9.65	-
D1	6.55	6.95	-
е	:	2.54 T\	/P
Е	9.66	10.66	-
E1	6.23	8.23	-
Н	14.61	15.87	-
L	1.78	2.79	-
L1	-	1.67	-
L2	-	1.77	-
L3	-	-	0.254
а	0°	8°	-
All Dimensions in mm			

### (2) TO263AB (D2PAK) (Type TH)



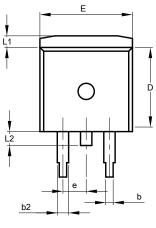
TO263AB (D2PAK)				
(Type TH)				
Dim	Min	Max	Тур	
Α	4.40	4.70	4.57	
A1	0.00	0.20	0.10	
A2	2.59	2.79	2.69	
b	0.77	0.90	0.813	
b2	1.20	1.36	1.27	
С	0.356	0.47	0.381	
c2	1.22	1.32	1.27	
D	8.60	8.80	8.70	
D1	6.60	7.80	7.60	
D1a	5.33	6.53	6.33	
D1b	4.54	5.74	5.54	
е	2	.54 BS	O	
Е	10.00	10.20	10.10	
E1	6.67	7.87	7.67	
E1a	4.94	6.14	5.94	
E1b	7.06	8.26	8.06	
Н	14.70	15.50	15.10	
L	2.00	2.60	2.30	
L1	1.17	1.40	1.27	
L2	1.45	1.70	1.55	
L3	0.25 BSC			
L4	2.50 REF			
θ	0°	8°	5°	
θ1	5°	9°	7°	
θ2	1°	5°	3°	
All Dimensions in mm				

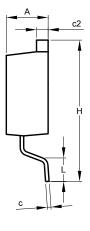


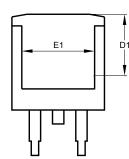
## Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

### (3) TO263AB (D2PAK) (Type BR)





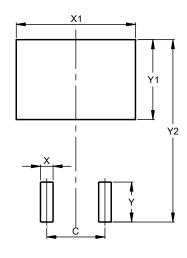


TO263AB (D2PAK)					
	(Type BR)				
Dim	Min	Max	Тур		
Α	4.30	4.70	-		
b	0.70	0.90	-		
b2	1.15	1.35	-		
С	0.40	0.60	-		
c2	1.20	1.40	-		
D	9.00	9.40	-		
D1	7.96	8.36	-		
Е	9.80	10.20	-		
E1	7.85	8.05	-		
е	2.34	2.74			
Н	15.00	15.87	-		
L	2.24	2.84	-		
L1	1.00	1.40	-		
L2	1.20	1.60	-		
All Dimensions in mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

### (1) TO263AB (D2PAK)



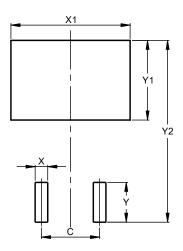
Dimensions	Value (in mm)
С	5.08
Х	1.10
X1	10.41
Υ	3.50
Y1	7.01
Y2	15 99



# Suggested Pad Layout (Cont.)

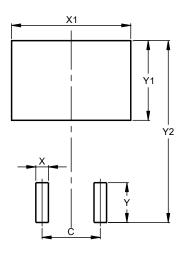
Please see http://www.diodes.com/package-outlines.html for the latest version.

### (2) TO263AB (D2PAK) (Type TH)



Dimensions	Value (in mm)
С	5.08
Х	1.10
X1	10.41
Y	3.50
Y1	7.01
Y2	15.99

### (3) TO263AB (D2PAK) (Type BR)



Dimensions	Value (in mm)
С	5.08
Х	1.10
X1	10.41
Υ	3.50
Y1	7.01
Y2	15 99



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